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(57) **ABSTRACT**

A multilayer coil component includes: an element body including a plurality of magnetic layers that includes soft magnetic metal particles and is laminated in a first direction; and a coil disposed in the element body. The coil includes a plurality of coil conductors electrically connected to each other. The plurality of magnetic layers includes a first magnetic layer and a second magnetic layer laminated between two coil conductors adjacent to each other in the first direction. An average particle diameter of soft magnetic metal particles included in the second magnetic layer is larger than an average particle diameter of soft magnetic metal particles included in the first magnetic layer.

